Travel Grant Application



PRiME 2012, Honolulu, HI

The Society's Battery, Corrosion, Dielectric Science & Technology, Electrodeposition, Electronics and Photonics, Energy Technology, High Temperature Materials (HTM), Industrial Electrochemistry and Electrochemical Engineering (IE&EE), Organic and Biological Electrochemistry (OBE), Physical and Analytical Electrochemistry, and Sensor Divisions offer travel grants to students presenting papers at the Society's next meeting, in Honolulu, HI, October 7-12, 2012. To apply, complete this application and send it along with a copy of your transcript and a letter from an involved faculty member attesting both to the quality of the student's work and financial needs, and a copy of the student's meeting abstract. For additional information please contact the Division contact below, as requirements might differ among Divisions.

Meeting Site:								
Name:								
School Address:								
nail:Phone #:								
Undergraduate Year (U) or Graduate Year (G) - circle one:	U3	U4	G1	G2	G3	G4	G5	
Major Subject:	Grade point average:out of possible:							
(please provide a letter of recommendation from your faculty advisor and a copy		_			•			
Symposium Title (#):								
Title of paper to be presented at the meeting:								
Are you an ECS Student Member of the Society? (if not, please additionally submit the Awarded Student Membership application)		l yes		□ no				
Estimated meeting expenditures: \$								
Signature:)ate:					
Check only one Division. (Applications made to multiple Di	visions v	will be reje	cted.)					
□ Battery—Send to: Christopher S. Johnson, Argonne National Lab, 9700 S. Cass Ave. #CSE-205, Argonne, IL 60439-4803, USA, e-mail: johnsoncs@cmt.anl.gov								
☐ Corrosion—Send to: N. Missert, Sandia National Labs, MS 141	5, P.O. Bo	ox 5800, Alb	ouquerque,	NM 87185	-0100, USA	, e-mail: na	amisse@sandia.gov	
☐ Dielectric Science & Technology—Send to: Peter Mascher, Ne-mail: mascher@mcmaster.ca	ЛсМaster	University,	Engineeri	ng Physics	Dept., Har	nilton, Ont	ario L8S-4L7, Cana	ada,
☐ Electrodeposition—Send to: Philippe M. Vereecken, IMEC, 3	3001 Leu	ven, Kapeld	lreef 75, B	elgium, e-1	nail: Philip	pe.Vereeck	en@imec.be	
☐ Electronics and Photonics—Send to: F. Ren, University of Fl	orida, De	pt. of Chem	n. Engr., G	ainesville,	FL 32611,	USA, e-ma	il: ren@che.ufl.edu	
☐ Energy Technology—Send to: Vaidyanathan (Ravi) Subramar USA, email: ravisv@unr.edu	nian, Che	emical and N	Materials E	Engineering	g Dept., Uni	versity of	Nevada, Reno, NV	89557,
☐ HTM—Send to: Greg Jackson, Dept. of Mechanical Engineer e-mail: gsjackso@umd.edu	ring, 218	1 Martin Ha	all, Univer	sity of Ma	yland, Coll	ege Park, l	MD 20742, USA,	
☐ IE&EE—Send to: John Staser, Cond. La Ciudadela 602, Ave.	. Las Cun	mbres #2, G	uaynabo, (00969 Puei	to Rico, e-1	nail: staser	.john@gmail.com	
☐ OBE—Send to: D. G. Peters, Dept. of Chemistry, Indiana Un	iversity,	800 E. Kirk	wood Ave	., Bloomin	gton, IN 47	405, USA,	e-mail: peters@ind	liana.edu
Physical and Analytical Electrochemistry—Send to: Andrew 2122 Sweeney Hall, Iowa State University, Ames, IA 50011,					Dept. of Cl	nemical an	d Biological Engine	eering,
☐ Sensor—Send to: Y-L. Chang, Director, Device Characterizate-mail: ylchang@kiwylight.com	tion and I	Engineering	, Glo-USA	, 1225 Bo	rdeaux Dr.,	Sunnyvale	, CA 94089, USA,	

www.electrochem.org/sponsorship/travel_grants.htm

Applications for Travel Grants for the PRiME 2012, Honolulu, HI meeting must be received no later than April 13, 2012.